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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Applicant:

Leonard C. Pipes et al.

Serial No.: 10/764,751

Filed: January 26, 2004

For: Implanting Ions in Shallow
Trench Isolation Structures

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Art Unit: 2812

Examiner: Stanetta D. Isaac

Atty Docket: ITL.0851D1US
P15016D

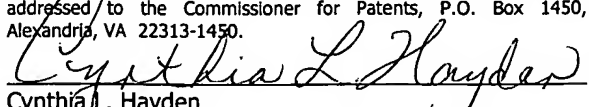
Assignee: Intel Corporation

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

REPLY TO PAPER NO. 0305

Sir:

In response to the office action mailed March 25, 2005, please amend the above-referenced patent application as follows:

Date of Deposit: May 26, 2005
I hereby certify under 37 CFR 1.8(a) that this correspondence is being deposited with the United States Postal Service as **first class mail** with sufficient postage on the date indicated above and is addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Cynthia L. Hayden